

<u>LT5519</u>

0.7GHz to 1.4GHz High Linearity Upconverting Mixer

FEATURES

- Wide RF Frequency Range: 0.7GHz to 1.4GHz
- 17.1dBm Typical Input IP3 at 1GHz
- On-Chip RF Output Transformer
- On-Chip 50 Ω Matched LO and RF Ports
- Single-Ended LO and RF Operation
- Integrated LO Buffer: –5dBm Drive Level
- Low LO to RF Leakage: 44dBm Typical
- Noise Figure: 13.6dB
- Wide IF Frequency Range: 1MHz to 400MHz
- Enable Function with Low Off-State Leakage Current
- Single 5V Supply
- Small 16-Lead QFN Plastic Package

APPLICATIONS

- Wireless Infrastructure
- Cable Downlink Infrastructure
- Point-to-Point and Point-to-Multipoint Data Communications
- High Linearity Frequency Conversion

TYPICAL APPLICATION

DESCRIPTION

The LT[®]5519 mixer is designed to meet the high linearity requirements of wireless and cable infrastructure transmission systems. A high speed, internally 50Ω matched, LO amplifier drives a double-balanced mixer core, allowing the use of a low power, single-ended LO source. An RF output transformer is integrated, thus eliminating the need for external matching components at the RF output, while reducing system cost, component count, board area and system-level variations. The IF port can be easily matched to a broad range of frequencies for use in many different applications.

The LT5519 mixer delivers +17.1dBm typical input 3rd order intercept point at 1GHz with IF input signal levels of -10dBm. The input 1dB compression point is typically +5.5dBm. The IC requires only a single 5V supply.

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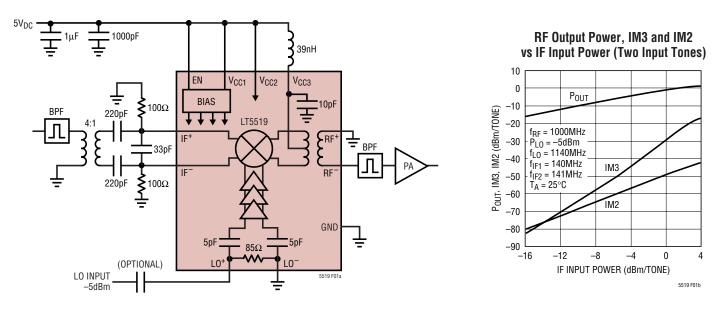


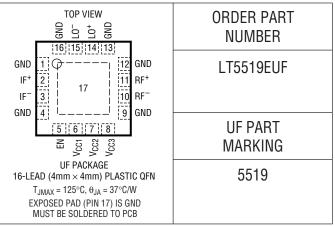
Figure 1. Frequency Conversion in Wireless Infrastructure Transmitter



ABSOLUTE MAXIMUM RATINGS

(Note 1)	
Supply Voltage 5.5V	/
Enable Voltage $-0.3V$ to $(V_{CC} + 0.3V)$)
LO Input Power (Differential) +10dBm	l
LO ⁺ to LO ⁻ Differential DC Voltage ± 1 V	/
LO ⁺ and LO ⁻ DC Common Mode Voltage $-1V$ to V _{CC}	2
IF Input Power (Differential)+10dBm	1
IF ⁺ and IF ⁻ DC Currents 25mA	ł
RF ⁺ to RF ⁻ Differential DC Voltage ±0.13V	/
RF ⁺ and RF ⁻ DC Common Mode Voltage $-1V$ to V _{CC}	3
Operating Temperature Range40°C to 85°C)
Storage Temperature Range65°C to 125°C)
Junction Temperature (T _J) 125°C)

PACKAGE/ORDER INFORMATION



Consult LTC Marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS

PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS
IF Input Frequency Range			1 to 400		MHz
LO Input Frequency Range		300 to 1800		MHz	
RF Output Frequency Range			700 to 1400)	MHz

1GHz Application: $V_{CC} = 5V_{DC}$, EN = High, $T_A = 25^{\circ}C$, IF input = 140MHz at -10dBm, LO input = 1.14GHz at -5dBm, RF output measured at 1GHz, unless otherwise noted. (Test circuit shown in Figure 2) (Notes 2, 3)

PARAMETER	CONDITIONS	MIN TYP MAX	UNITS
IF Input Return Loss	$Z_0 = 50\Omega$, with External Matching	20	dB
LO Input Return Loss	Z ₀ = 50Ω	17	dB
RF Output Return Loss	Z ₀ = 50Ω	20	dB
LO Input Power		-10 to 0	dBm
Conversion Gain		-0.6	dB
Input 3rd Order Intercept	-10dBm/Tone, ∆f = 1MHz	17.1	dBm
Input 2nd Order Intercept	–10dBm, Single Tone	48	dBm
LO to RF Leakage		-44	dBm
LO to IF Leakage		-40	dBm
Input 1dB Compression		5.5	dBm
IF Common Mode Voltage	Internally Biased	1.77	V _{DC}
Noise Figure	Single-Side Band	13.6	dB



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DC ELECTRICAL CHARACTERISTICS

(Test Circuit Shown in Figure 2) $V_{CC} = 5V_{DC}$, EN = High, $T_A = 25^{\circ}C$, unless otherwise noted. (Note 3)

PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS
Enable (EN) Low = OFF, High = ON					
Turn-On Time (Note 4)			2		μs
Turn-Off Time (Note 4)			6		μs
Input Current	V _{ENABLE} = 5V _{DC}		1	10	μA
Enable = High (ON)		3			V _{DC}
Enable = Low (OFF)				0.5	V _{DC}
Power Supply Requirements (V _{CC})					
Supply Voltage		4.5	to 5.25		V _{DC}
Supply Current	$V_{CC} = 5V_{DC}$		60	70	mA
Shutdown Current	EN = Low		1	100	μA

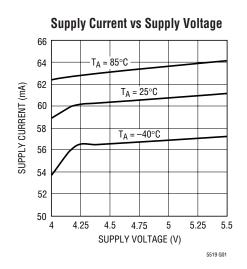
Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

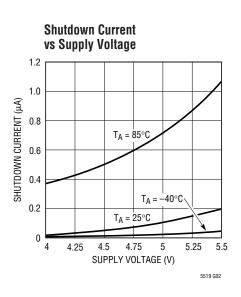
Note 2: External components on the final test circuit are optimized for operation at f_{RF} = 1GHz, f_{LO} = 1.14GHz and f_{IF} = 140MHz.

Note 3: Specifications over the -40° C to 85° C temperature range are assured by design, characterization and correlation with statistical process controls.

Note 4: Turn-On and Turn-Off times are based on the rise and fall times of the RF output envelope from -40dBm to full power with an IF input power of -10dBm.

TYPICAL PERFORMANCE CHARACTERISTICS (Test Circuit Shown in Figure 2)

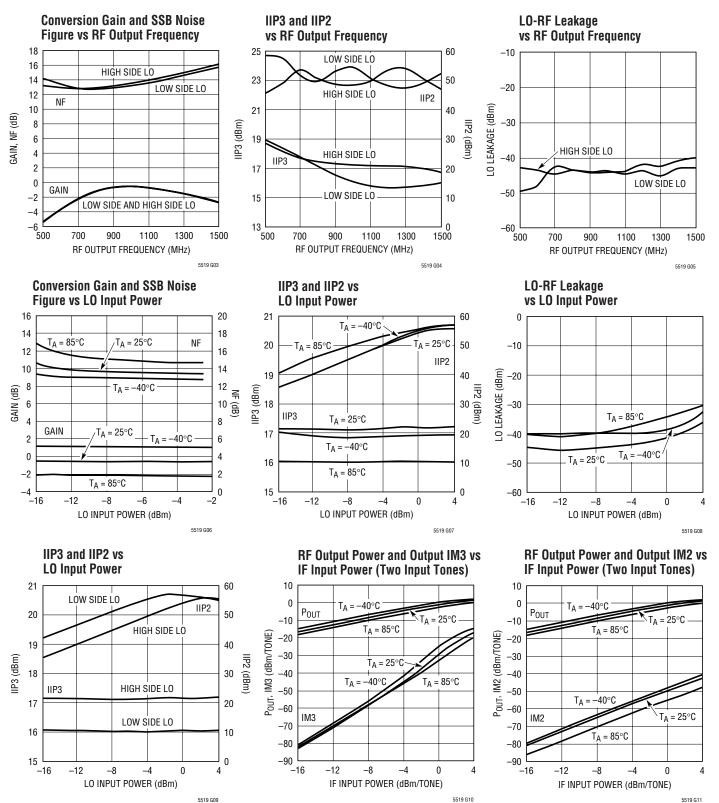






TYPICAL PERFORMANCE CHARACTERISTICS

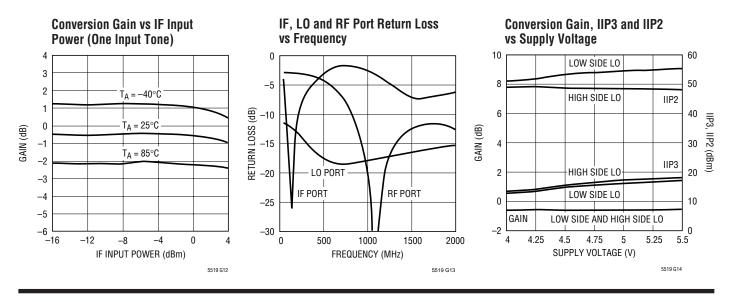
 V_{CC} = 5 V_{DC} , EN = High, T_A = 25°C, IF input = 140MHz at –10dBm, LO input = 1.14GHz at –5dBm, RF output measured at 1000MHz, unless otherwise noted. For 2-tone inputs: 2nd IF input = 141MHz at -10dBm. (Test Circuit Shown in Figure 2.)





TYPICAL PERFORMANCE CHARACTERISTICS

V_{CC} = 5V_{DC}, EN = High, T_A = 25°C, IF input = 140MHz at -10dBm, LO input = 1.14GHz at -5dBm, RF output measured at 1000MHz, unless otherwise noted. For 2-tone inputs: 2nd IF input = 141MHz at -10dBm. (Test Circuit Shown in Figure 2.)



PIN FUNCTIONS

GND (Pins 1, 4, 9, 12, 13, 16): Internal Grounds. These pins are used to improve isolation and are not intended as DC or RF grounds for the IC. Connect these pins to low impedance grounds on the PCB for best performance.

IF⁺, **IF**⁻ (**Pins 2, 3**): Differential IF Signal Inputs. A differential signal must be applied to these pins through DC blocking capacitors. The pins must be connected to ground with 100Ω resistors (the grounds must each be capable of sinking about 18mA). For best LO leakage performance, these pins should be DC isolated from each other. An impedance transformation is required to match the IF input to the desired source impedance (typically 50Ω or 75Ω).

EN (Pin 5): Enable Pin. When the applied voltage is greater than 3V, the IC is enabled. When the applied voltage is less than 0.5V, the IC is disabled and the DC current drops to about 1μ A.

 V_{CC1} (Pin 6): Power Supply Pin for the Bias Circuits. Typical current consumption is about 2mA. This pin should be externally connected to V_{CC} and have appropriate RF bypass capacitors.

V_{CC2} (Pin 7): Power Supply Pin for the LO Buffer Circuits. Typical current consumption is about 22mA. This pin should have appropriate RF bypass capacitors as shown in Figure 2. The 1000pF capacitor should be located as close to the pins as possible.

 V_{CC3} (Pin 8): Power Supply Pin for the Internal Mixer. Typical current consumption is about 36mA. This pin should be externally connected to V_{CC} through an inductor. A 39nH inductor is shown in Figure 2, though the value is not critical.

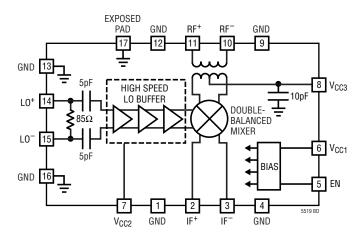
RF⁻, RF⁺ (Pins 10, 11): Differential RF Outputs. One pin may be DC connected to a low impedance ground to realize a 50Ω single-ended output. No external matching components are required. A DC voltage should not be applied across these pins, as they are internally connected through a transformer winding.

L0⁺, L0⁻ (Pins 14, 15): Differential Local Oscillator Inputs. The LT5519 works well with a single-ended source driving the L0⁺ pin and the L0⁻ pin connected to a low impedance ground. No external 50Ω matching components are required. An internal resistor is connected across these pins; therefore, a DC voltage should not be applied across the inputs.

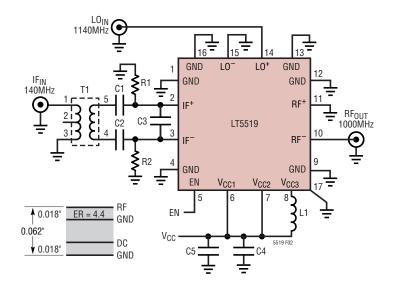
Exposed Pad (Pin 17): DC and RF ground return for the entire IC. This must be soldered to the printed circuit board low impedance ground plane.



BLOCK DIAGRAM



TEST CIRCUIT



REF DES	VALUE	SIZE	PART NUMBER
C1, C2	220pF	0402	AVX 04023C221KAT2A
C3	33pF	0402	AVX 04023A330KAT2A
C4	1000pF	0402	AVX 04023A102KAT2A
C5	1µF	0603	Taiyo Yuden LMK107BJ105MA
L1	39nH	0402	Toko LL1005-FH39NJ
R1, R2	100Ω, 0.1%	0603	IRC PFC-W0603R-03-10R1-B
T1	4:1	SM-22	M/A-COM ETC4-1-2

Figure 2. Test Schematic for the LT5519



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APPLICATIONS INFORMATION

The LT5519 consists of a double-balanced mixer, a high performance LO buffer and bias/enable circuits. The RF and LO ports may be driven differentially; however, they are intended to be used in single-ended mode by connecting one input of each pair to ground. The IF input ports must be DC-isolated from the source and driven differentially. The IF input should be impedance-matched for the desired input frequency. The LO input has an internal broadband 50 Ω match with return loss better than 10dB at frequencies up to 1800MHz. The RF output band ranges from 700MHz to 1400MHz, with an internal RF transformer providing a 50 Ω impedance match across the band. Low side or high side LO injection can be used.

IF Input Port

The IF inputs are connected to the emitters of the doublebalanced mixer transistors, as shown in Figure 3. These pins are internally biased and an external resistor must be connected from each IF pin to ground to set the current through the mixer core. The circuit has been optimized to work with 100Ω resistors, which will result in approximately 18mA of DC current per side. For best LO leakage performance, the resistors should be well matched; thus resistors with 0.1% tolerance are recommended. If LO leakage is not a concern, then lesser tolerance resistors can be used. The symmetry of the layout is also important for achieving optimum LO isolation.

The capacitors shown in Figure 3, C1 and C2, serve two purposes. They provide DC isolation between the IF^+ and IF^- ports, thus preventing DC interactions that could cause unpredictable variations in LO leakage. They also

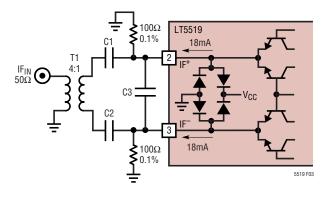


Figure 3. IF Input with External Matching

improve the impedance match by canceling excess inductance in the package and transformer. The input capacitor value required to realize an impedance match at desired frequency, f, can be estimated as follows:

$$C_1 = C_2 = \frac{1}{(2\pi f)^2 (L_{IN} + L_{EXT})}$$

where; f is in units of Hz, L_{IN} and L_{EXT} are in Henry, and C1, C2 are in Farad. L_{IN} is the differential input inductance of the LT5519, and is approximately 1.67nH. L_{EXT} represents the combined inductances of differential external components and transmission lines. For the evaluation board shown in Figure 10, L_{EXT} = 4.21nH. Thus, for f = 140MHz, the above formula gives C1 = C2 = 220pF.

Table 1 lists the differential IF input impedance and reflection coefficient for several frequencies. A 4:1 balun can be used to transform the impedance up to about 50Ω .

Table 1.	. IF Inpu	t Differential	Impedance
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FREQUENCY	DIFFERENTIAL	DIFFEREN	ITIAL S11
(MHz)	INPUT IMPEDANCE	MAG	ANGLE
10	10.1 + j0.117	0.663	180
44	10.1 + j0.476	0.663	179
70	10.1 + j0.751	0.663	178
140	10.2 + j1.47	0.663	177
170	10.2 + j1.78	0.663	176
240	10.2 + j2.53	0.663	174
360	10.2 + j3.81	0.663	171
500	10.2 + j5.31	0.663	167

LO Input Port

The simplified circuit for the LO buffer input is shown in Figure 4. The LO buffer amplifier consists of high speed limiting differential amplifiers, optimized to drive the mixer quad for high linearity. The LO⁺ and LO⁻ ports can be driven differentially; however, they are intended to be driven by a single-ended source. An internal resistor connected across the LO⁺ and LO⁻ inputs provides a broadband 50 Ω impedance match. Because of the resistive match, a DC voltage at the LO input is not recommended. If the LO signal source output is not AC coupled, then a DC blocking capacitor should be used at the LO input.



APPLICATIONS INFORMATION

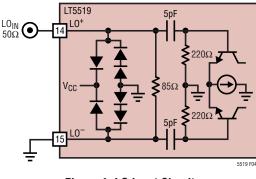


Figure 4. LO Input Circuit

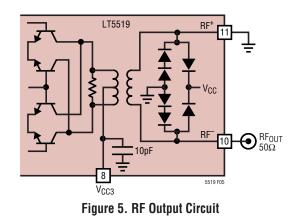
Though the LO input is internally matched to 50Ω , there may be some cases, particularly at higher frequencies or with different source impedances, where a further optimized match is desired. Table 2 includes the single-ended input impedance and reflection coefficient vs frequency for the LO input for use in such cases.

FREQUENCY	INPUT	S1	1
(MHz)	IMPEDANCE	MAG	ANGLE
200	72.3 – j16.1	0.223	-28.4
400	63.3 — j11.3	0.153	-34.7
600	61.6 – j7.5	0.124	-29.2
800	61.9 — j6.0	0.119	-23.6
1000	62.7 – j6.1	0.125	-22.7
1200	63.2 - j7.4	0.134	-25.5
1400	63.3 — j9.5	0.144	-30.8
1600	62.8 - j12.0	0.155	-37.1
1800	61.6 - j14.2	0.163	-43.4

Table 2. Single-Ended LO Input Impedance

RF Output Port

An internal RF transformer, shown in Figure 5, reduces the mixer-core impedance to provide an impedance of 50Ω across the RF⁺ and RF⁻ pins. The LT5519 is designed and tested with the outputs configured for single-ended operation, as shown in the Figure 5; however, the outputs can be used differentially as well. A center tap in the transformer provides the DC connection to the mixer core and the transformer provides DC isolation at the RF output. The



RF⁺ and RF⁻ pins are connected together through the secondary windings of the transformer; thus a DC voltage should not be applied across these pins.

The impedance data for the RF output, listed in Table 3, can be used to develop matching networks for different load impedances.

Table 3. Single-Ended RF Output Impedance

FREQUENCY	OUTPUT	S1	1
(MHz)	IMPEDANCE	MAG	ANGLE
700	27.6 + j32.0	0.465	103
800	39.7 + j32.1	0.354	88.1
900	50.9 + j23.5	0.227	74.7
1000	53.5 + j10.3	0.105	65.5
1100	48.3 + j1.3	0.022	143
1200	42.0 - j3.1	0.093	-157
1300	36.6 - j3.4	0.159	-164
1400	33.0 - j2.0	0.207	-172

Operation at Different Input Frequencies

On the evaluation board shown in Figure 10, the input of the LT5519 can be easily matched for different frequencies by changing the capacitors, C1, C2 and C3. Capacitors C1 and C2 set the input matching frequency while C3 improves the LO to RF leakage performance. Decreasing the value of C3 at higher input frequencies reduces its impact on conversion gain. Table 4 lists some actual values used at selected frequencies.



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APPLICATIONS INFORMATION

FREQUENCY (MHz)	CAPACITANCE (C1, C2) (pF)	CAPACITANCE (C3) (pF)		
44	2200	33		
70	820	33		
140	220	33		
240	68	15		
300	39	6.8		
350	27	6.8		
440	18	6.8		

Table 4. Input Capacitor Values vs Frequency

The performance was evaluated with the input tuned for each of these frequencies and the results are summarized in Figures 6-8. The same IF input balun transformer was used for all measurements. In each case, the LO input

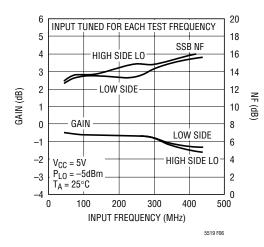


Figure 6. Conversion Gain and Single Sideband Noise Figure vs Tuned IF Input Frequency

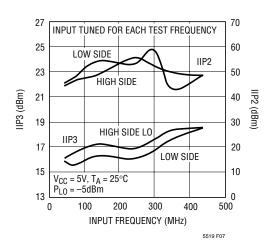


Figure 7. IIP3 and IIP2 vs Tuned IF Input Frequency

frequency was adjusted to maintain an RF output frequency of 1000MHz.

Low Frequency Matching of the RF Output Port

Without any external components on the RF output, the internal transformer of the LT5519 provides a good 50Ω impedance match for RF frequencies above approximately 850MHz. Below this frequency, the return loss drops below 10dB and degrades the conversion gain. The addition of a single 10pF capacitor in series with the RF output improves the match at lower RF frequencies, shifting the 10dB return loss point to about 700MHz, as demonstrated in Figure 9. This change also results in an improvement of the conversion gain.

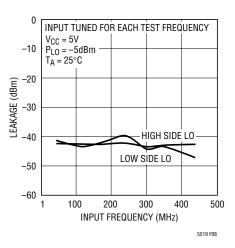
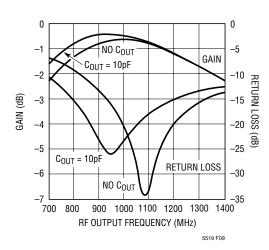


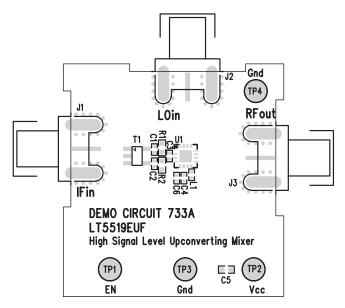
Figure 8. LO to RF Leakage vs Tuned IF Input Frequency



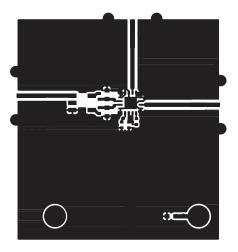




TYPICAL APPLICATIONS



(10a) Top Layer Silkscreen



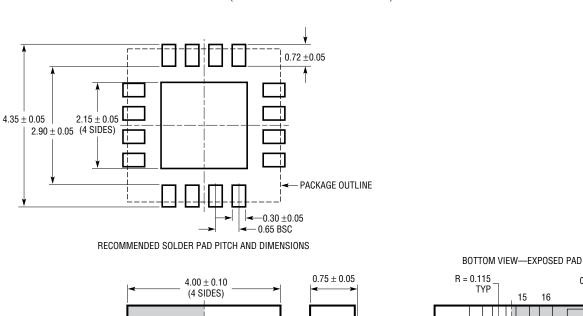
(10b) Top Layer Metal

Figure 10. Evaluation Board Layout

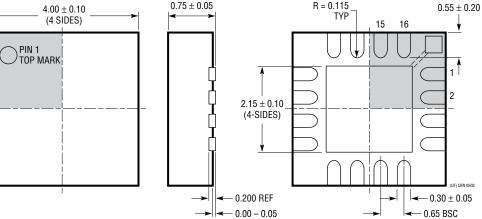


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PACKAGE DESCRIPTION



UF Package 16-Lead Plastic QFN ($4mm \times 4mm$) (Reference LTC DWG # 05-08-1692)



NOTE:

1. DRAWING CONFORMS TO JEDEC PACKAGE OUTLINE MO-220 VARIATION (WGGC)

2. ALL DIMENSIONS ARE IN MILLIMETERS 3. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE

MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE

4. EXPOSED PAD SHALL BE SOLDER PLATED

